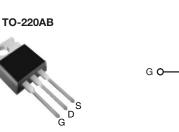


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Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	600				
R _{DS(on)} (Ω)	V _{GS} = 10 V 2.2				
Q _g (Max.) (nC)	23				
Q _{gs} (nC)	5.4				
Q _{gd} (nC)	11				
Configuration	Single				



N-Channel MOSFET

FEATURES

 \bullet Low Gate Charge ${\rm Q}_{\rm g}$ Results in Simple Drive Requirement



- Improved Gate, Avalanche and Dynamic dV/dt RoHS Ruggedness
- Fully Characterized Capacitance and Avalanche Voltage and Current
- Effective Coss Specified
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Switch Mode Power Supply (SMPS)
- Uninterruptable Power Supply
- High Speed Power Switching

TYPICAL SMPS TOPOLOGY

• Single Transistor Flyback

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRFBC30APbF			
	SiHFBC30A-E3			
SnPb	IRFBC30A			
	SiHFBC30A			

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	600	v	
Gate-Source Voltage			V _{GS}	± 30	v	
Continuous Drain Current	N	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$	- I _D	3.6		
	V _{GS} at 10 V	T _C = 100 °C		2.3	А	
Pulsed Drain Current ^a			I _{DM}	14		
Linear Derating Factor				0.69	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	290	mJ	
Repetitive Avalanche Current ^a			I _{AR}	3.6	А	
Repetitive Avalanche Energy ^a			E _{AR}	7.4	mJ	
Maximum Power Dissipation $T_{C} = 25 \text{ °C}$			PD	74	W	
Peak Diode Recovery dV/dtc			dV/dt	7.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for	10 s		300 ^d		
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting Torque				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Starting $T_J = 25$ °C, L = 41 mH, $R_g = 25 \Omega$, $I_{AS} = 3.6$ A (see fig. 12).

c. $I_{SD} \leq 3.6$ A, dI/dt ≤ 170 A/µs, $V_{DD} \leq V_{DS}, \, T_J \leq 150 \ ^\circ C.$

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.	MAX.		UNIT	
Maximum Junction-to-Ambient	R _{thJA}	- 62 0.50 - 1.7						
Case-to-Sink, Flat, Greased Surface	R _{thCS}				°C/W			
Maximum Junction-to-Case (Drain)	R _{thJC}							
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u	Inless otherw	ise noted)						
PARAMETER	SYMBOL	TES		ONS	MIN.	TYP.	MAX.	UNIT
Static								•
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 25	50 µA	600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I	_D = 1 mA	-	0.67	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V_{GS} , $I_D = 28$	50 µA	2.0	-	4.5	V
Gate-Source Leakage	I _{GSS}	١	/ _{GS} = ± 30 \	1	-	-	± 100	nA
Zava Cata Valtaga Drain Current		V _{DS} =	$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 480 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 ^{\circ}\text{C}$		-	-		
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 480 V			-	-	250	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D :	= 2.2 A ^b	-	-	2.2	Ω
Forward Transconductance	g _{fs}	V _{DS} =	50 V, I _D = 2	2.2 A ^b	2.1	-	-	S
Dynamic							-	
Input Capacitance	C _{iss}	V _{GS} = 0 V,		-	510	-		
Output Capacitance	C _{oss}		$V_{DS} = 25 V,$		-	70	-	
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	3.5	-	ъĘ	
Output Capacitance	C		V _{DS} = 1.0	V _{DS} = 1.0 V, f = 1.0 MHz	-	730	-	pF
Output Capacitance	C _{oss}	$V_{GS} = 0 V$ $V_{DS} = 480 V$		V, f = 1.0 MHz	-	19	-	[
Effective Output Capacitance	C _{oss} eff.		$V_{DS} = 0$	V to 480 V ^c	-	31	-	
Total Gate Charge	Qg			-	-	23		
Gate-Source Charge	Q _{gs}	V _{GS} = 10 V	I _D = 3.6 A see fig	$I_D = 3.6 \text{ A}, V_{DS} = 480 \text{ V}$ see fig. 6 and 13^{b}	-	-	5.4	nC
Gate-Drain Charge	Q _{gd}				-	-	11	
Turn-On Delay Time	t _{d(on)}				-	9.8	-	
Rise Time	tr	- 	000 1/ 1	0.0.4	_	13	-	
Turn-Off Delay Time	t _{d(off)}	$V_{DD} = 300 \text{ V}, \text{ I}_{D} = 3.6 \text{ A}, \\ \text{R}_{g} = 12 \ \Omega, \text{ R}_{D} = 82 \ \Omega, \text{ see fig. } 10^{\text{b}}$		_	19	-	ns	
Fall Time	t _f			-	12	-		
Drain-Source Body Diode Characteristic	cs							1
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	3.6	A	
Pulsed Diode Forward Current ^a	I _{SM}			-	-	14	A	
Body Diode Voltage	V _{SD}	$T_J = 25 \text{ °C}, I_S = 3.6 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	1.6	V	
Body Diode Reverse Recovery Time	t _{rr}				-	400	600	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = 3.6 \text{ A}, \text{ dl/dt} = 100 \text{ A/}\mu\text{s}^b$			-	1.1	1.7	μC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn			-on is do	minated h	v loand	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

c. C_{oss} eff. is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

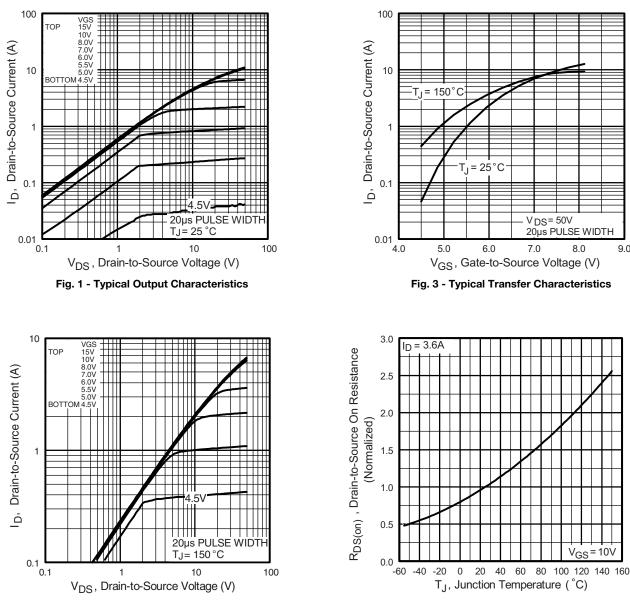
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 2 - Typical Output Characteristics

Fig. 4 - Normalized On-Resistance vs. Temperature

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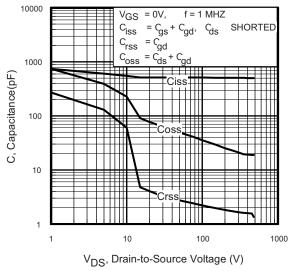


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

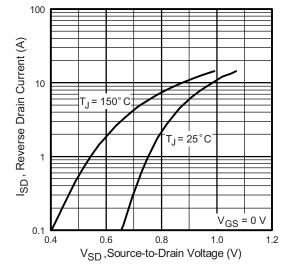


Fig. 7 - Typical Source-Drain Diode Forward Voltage

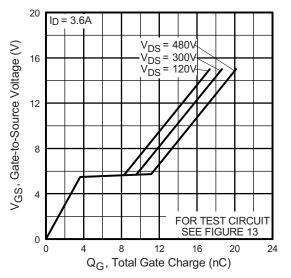


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

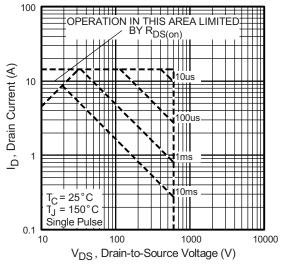
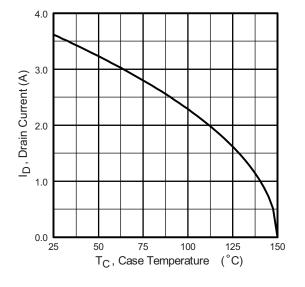


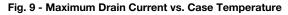
Fig. 8 - Maximum Safe Operating Area

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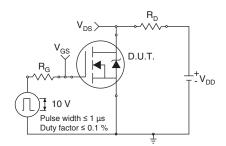


Fig. 10a - Switching Time Test Circuit

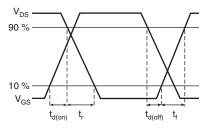
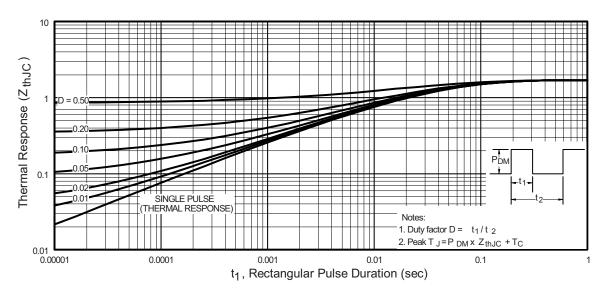
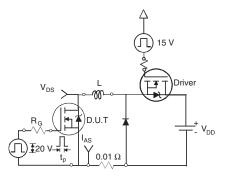
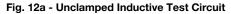


Fig. 10b - Switching Time Waveforms









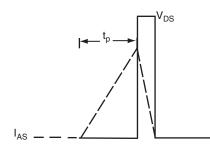
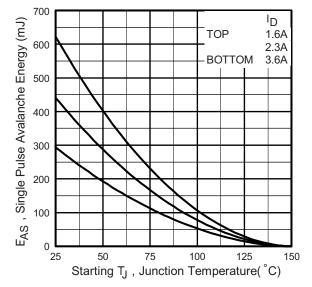


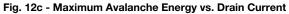
Fig. 12b - Unclamped Inductive Waveforms

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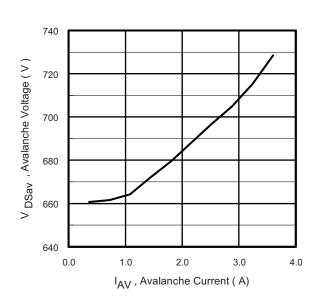
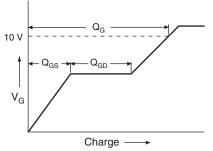


Fig. 12d - Typical Drain-to-Source Voltage vs. Avalanche Current





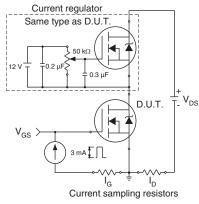


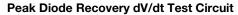
Fig. 13b - Gate Charge Test Circuit

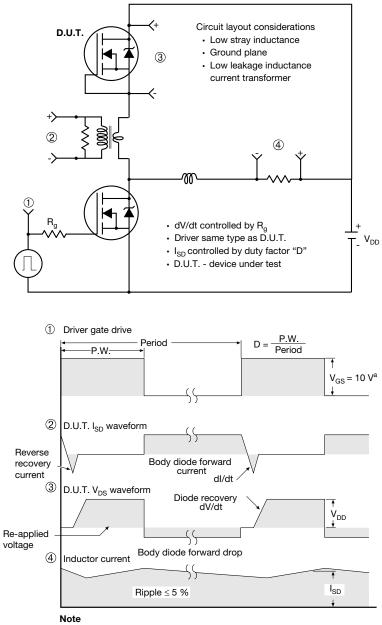
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a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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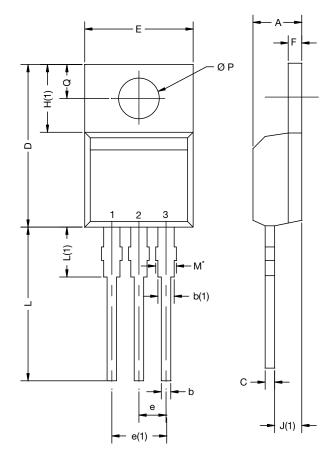
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TO-220-1



DIM.	MILLIN	IETERS	INCHES		
DIIVI.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØΡ	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

• $M^* = 0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture					
ASE		Xi'an			
		IRF 9510 744K AB			

Revison: 14-Dec-15

Document Number: 66542

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